- **Choice of Eight Latches or Eight D-Type Flip-Flops in a Single Package**
- **3-State Bus-Driving Outputs**
- **Full Parallel Access for Loading**
- **Buffered Control Inputs**
- **Clock-Enable Input Has Hysteresis to Improve Noise Rejection ('S373 and 'S374)**
- **P-N-P Inputs Reduce DC Loading on Data Lines ('S373 and 'S374)**

description

These 8-bit registers feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. The high-impedance 3-state and increased high-logic-level drive provide these registers with the capability of being connected directly to and driving the bus lines in a bus-organized system without need for interface or pullup components. These devices are particularly attractive for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.
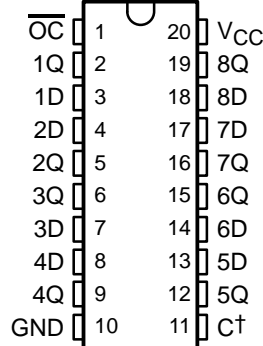
The eight latches of the 'LS373 and 'S373 are transparent D-type latches, meaning that while the enable (C or CLK) input is high, the Q outputs follow the data (D) inputs. When C or CLK is taken low, the output is latched at the level of the data that was set up.

The eight flip-flops of the 'LS374 and 'S374 are edge-triggered D-type flip-flops. On the positive transition of the clock, the Q outputs are set to the logic states that were set up at the D inputs.

SN54LS373, SN54LS374, SN54S373,
SN54S374 . . . J OR W PACKAGE
SN74LS373, SN74LS374 . . . DW, N, OR NS PACKAGE
SN74LS374 . . . DB, DW, N, OR NS PACKAGE
SN74S373 . . . DW OR N PACKAGE
(TOP VIEW)

$\overline{OC}$	1		20	V_{CC}
1Q	2		19	8Q
1D	3		18	8D
2D	4		17	7D
2Q	5		16	7Q
3Q	6		15	6Q
3D	7		14	6D
4D	8		13	5D
4Q	9		12	5Q
GND	10		11	C†

† C for 'LS373 and 'S373; CLK for 'LS374 and 'S374.

SN54LS373, SN54LS374, SN54S373,
SN54S374 . . . FK PACKAGE
(TOP VIEW)

Top pins: 1D 1Q $\overline{OC}$ V$_{CC}$ 8Q (pins 3 2 1 20 19)

2D	4	18 8D
2Q	5	17 7D
3Q	6	16 7Q
3D	7	15 6Q
4D	8	14 6D

Bottom pins: 4Q GND C† 5Q 5D (pins 9 10 11 12 13)

† C for 'LS373 and 'S373; CLK for 'LS374 and 'S374.

Schmitt-trigger buffered inputs at the enable/clock lines of the 'S373 and 'S374 devices simplify system design as ac and dc noise rejection is improved by typically 400 mV due to the input hysteresis. A buffered output-control ($\overline{OC}$) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly.
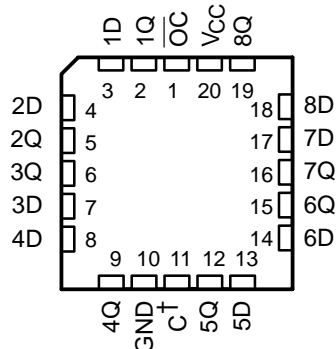
$\overline{OC}$ does not affect the internal operation of the latches or flip-flops. That is, the old data can be retained or new data can be entered, even while the outputs are off.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

TEXAS INSTRUMENTS

ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	PDIP – N	Tube	SN74LS373N	SN74LS373N
		Tube	SN74LS374N	SN74LS374N
		Tube	SN74S373N	SN74S373N
		Tube	SN74S374N	SN74S374N
	SOIC – DW	Tube	SN74LS373DW	LS373
		Tape and reel	SN74LS373DWR	
		Tube	SN74LS374DW	LS374
		Tape and reel	SN74LS374DWR	
		Tube	SN74S373DW	S373
		Tape and reel	SN74S373DWR	
		Tube	SN74S374DW	S374
		Tape and reel	SN74S374DWR	
	SOP – NS	Tape and reel	SN74LS373NSR	74LS373
		Tape and reel	SN74LS374NSR	74LS374
		Tape and reel	SN74S374NSR	74S374
	SSOP – DB	Tape and reel	SN74LS374DBR	LS374A
−55°C to 125°C	CDIP – J	Tube	SN54LS373J	SN54LS373J
		Tube	SNJ54LS373J	SNJ54LS373J
		Tube	SN54LS374J	SN54LS374J
		Tube	SNJ54LS374J	SNJ54LS374J
		Tube	SN54S373J	SN54S373J
		Tube	SNJ54S373J	SNJ54S373J
		Tube	SN54S374J	SN54S374J
		Tube	SNJ54S374J	SNJ54S374J
	CFP – W	Tube	SNJ54LS373W	SNJ54LS373W
		Tube	SNJ54LS374W	SNJ54LS374W
		Tube	SNJ54S374W	SNJ54S374W
	LCCC – FK	Tube	SNJ54LS373FK	SNJ54LS373FK
		Tube	SNJ54LS374FK	SNJ54LS374FK
		Tube	SNJ54S373FK	SNJ54S373FK
		Tube	SNJ54S374FK	SNJ54S374FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design
  guidelines are available at www.ti.com/sc/package.

TEXAS INSTRUMENTS

POST OFFICE BOX 655303 ● DALLAS, TEXAS 75265

Function Tables

'LS373, 'S373
(each latch)

INPUTS			OUTPUT
$\overline{OC}$	C	D	Q
L	H	H	H
L	H	L	L
L	L	X	Q_0
H	X	X	Z

'LS374, 'S374
(each latch)

INPUTS			OUTPUT
$\overline{OC}$	CLK	D	Q
L	↑	H	H
L	↑	L	L
L	L	X	Q_0
H	X	X	Z

TEXAS
INSTRUMENTS

logic diagrams (positive logic)

'LS373, 'S373
Transparent Latches

'LS374, 'S374
Positive-Edge-Triggered Flip-Flops

⚏ for 'S373 Only

⚏ for 'S374 Only
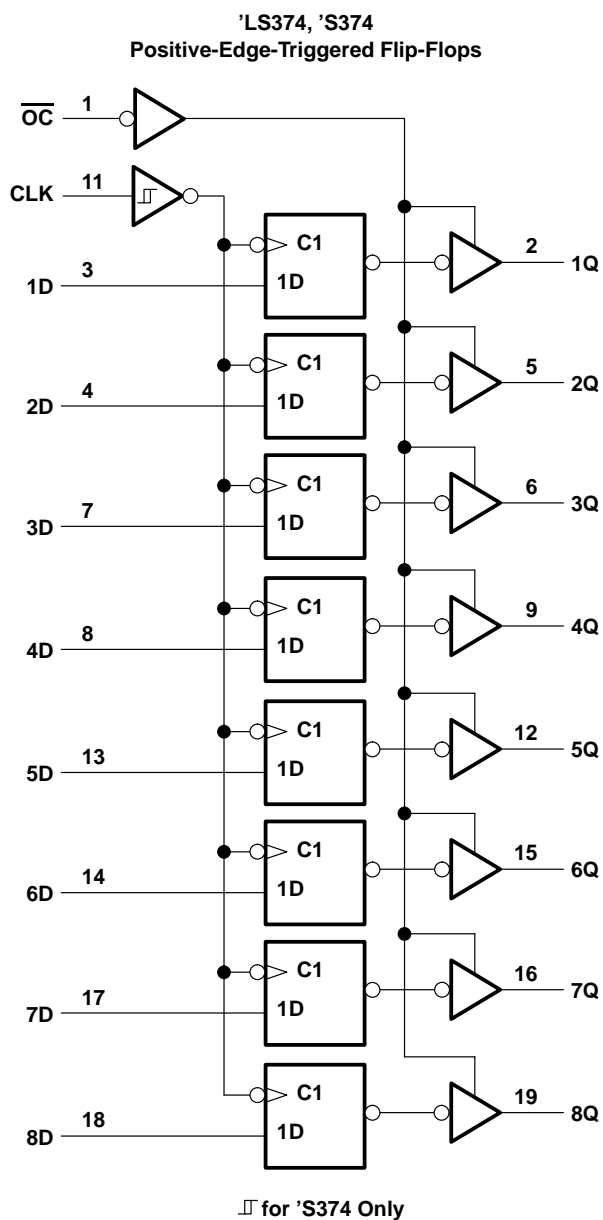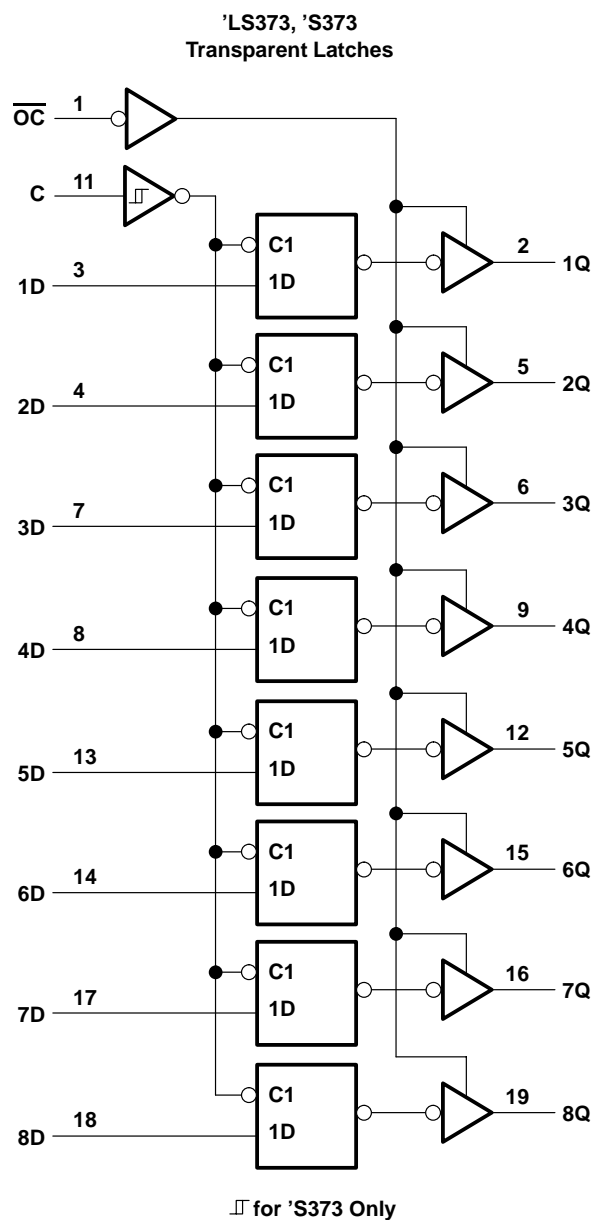
Pin numbers shown are for DB, DW, J, N, NS, and W packages.

schematic of inputs and outputs

'LS373

EQUIVALENT OF DATA INPUTS	EQUIVALENT OF ENABLE- AND OUTPUT-CONTROL INPUTS	TYPICAL OF ALL OUTPUTS

R_{eq} = 20 kΩ NOM   17 kΩ NOM   100 Ω NOM

'LS374

EQUIVALENT OF DATA INPUTS	EQUIVALENT OF CLOCK- AND OUTPUT-CONTROL INPUTS	TYPICAL OF ALL OUTPUTS

30 kΩ NOM   17 kΩ NOM   100 Ω NOM

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)† ('LS devices)

Supply voltage, V_{CC} (see Note 1) .... 7 V
Input voltage, V_I .... 7 V
Off-state output voltage .... 5.5 V
Package thermal impedance, θ_{JA} (see Note 2): DB package .... 70°C/W
DW package .... 58°C/W
N package .... 69°C/W
NS package .... 60°C/W
Storage temperature range, T_{stg} .... −65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
NOTES: 1. Voltage values are with respect to network ground terminal.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

			SN54LS'			SN74LS'			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5	5	4.75	5	5.25	V
V_{OH}	High-level output voltage				5.5			5.5	V
I_{OH}	High-level output current				−1			−2.6	mA
I_{OL}	Low-level output current				12			24	mA
t_w	Pulse duration	CLK high	15			15			ns
		CLK low	15			15			
t_{su}	Data setup time	'LS373	5↓			5↓			ns
		'LS374	20↑			20↑			
t_h	Data hold time	'LS373	20↓			20↓			ns
		'LS374‡	5↑			0↑			
T_A	Operating free-air temperature		−55		125	0		70	°C

‡ The t_h specification applies only for data frequency below 10 MHz. Designs above 10 MHz should use a minimum of 5 ns (commercial only).

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		SN54LS' MIN	SN54LS' TYP‡	SN54LS' MAX	SN74LS' MIN	SN74LS' TYP‡	SN74LS' MAX	UNIT
V_{IH}	High-level input voltage			2			2			V
V_{IL}	Low-level input voltage					0.7			0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN, I_I = −18 mA				−1.5			−1.5	V
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, $V_{IL} = V_{IL}$ max, I_{OH} = MAX		2.4	3.4		2.4	3.1		V
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, $V_{IL} = V_{IL}$ max	I_{OL} = 12 mA		0.25	0.4		0.25	0.4	V
			I_{OL} = 24 mA					0.35	0.5	
I_{OZH}	Off-state output current, high-level voltage applied	V_{CC} = MAX, V_{IH} = 2 V, V_O = 2.7 V				20			20	µA
I_{OZL}	Off-state output current, low-level voltage applied	V_{CC} = MAX, V_{IH} = 2 V, V_O = 0.4 V				−20			−20	µA
I_I	Input current at maximum input voltage	V_{CC} = MAX, V_I = 7 V				0.1			0.1	mA
I_{IH}	High-level input current	V_{CC} = MAX, V_I = 2.7 V				20			20	µA
I_{IL}	Low-level input current	V_{CC} = MAX, V_I = 0.4 V				−0.4			−0.4	mA
I_{OS}	Short-circuit output current§	V_{CC} = MAX		−30		−130	−30		−130	mA
I_{CC}	Supply current	V_{CC} = MAX, Output control at 4.5 V	'LS373		24	40		24	40	mA
			'LS374		27	40		27	40	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time and duration of the short circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'LS373 MIN	'LS373 TYP	'LS373 MAX	'LS374 MIN	'LS374 TYP	'LS374 MAX	UNIT
f_{max}			R_L = 667 Ω, C_L = 45 pF, See Note 3				35	50		MHz
t_{PLH}	Data	Any Q	R_L = 667 Ω, C_L = 45 pF, See Note 3		12	18				ns
t_{PHL}					12	18				
t_{PLH}	C or CLK	Any Q	R_L = 667 Ω, C_L = 45 pF, See Note 3		20	30		15	28	ns
t_{PHL}					18	30		19	28	
t_{PZH}	$\overline{OC}$	Any Q	R_L = 667 Ω, C_L = 45 pF, See Note 3		15	28		20	26	ns
t_{PZL}					25	36		21	28	
t_{PHZ}	$\overline{OC}$	Any Q	R_L = 667 Ω, C_L = 5 pF		15	25		15	28	ns
t_{PLZ}					12	20		12	20	

NOTE 3:   Maximum clock frequency is tested with all outputs loaded.

f_{max} = maximum clock frequency
t_{PLH} = propagation delay time, low-to-high-level output
t_{PHL} = propagation delay time, high-to-low-level output
t_{PZH} = output enable time to high level
t_{PZL} = output enable time to low level
t_{PHZ} = output disable time from high level
t_{PLZ} = output disable time from low level
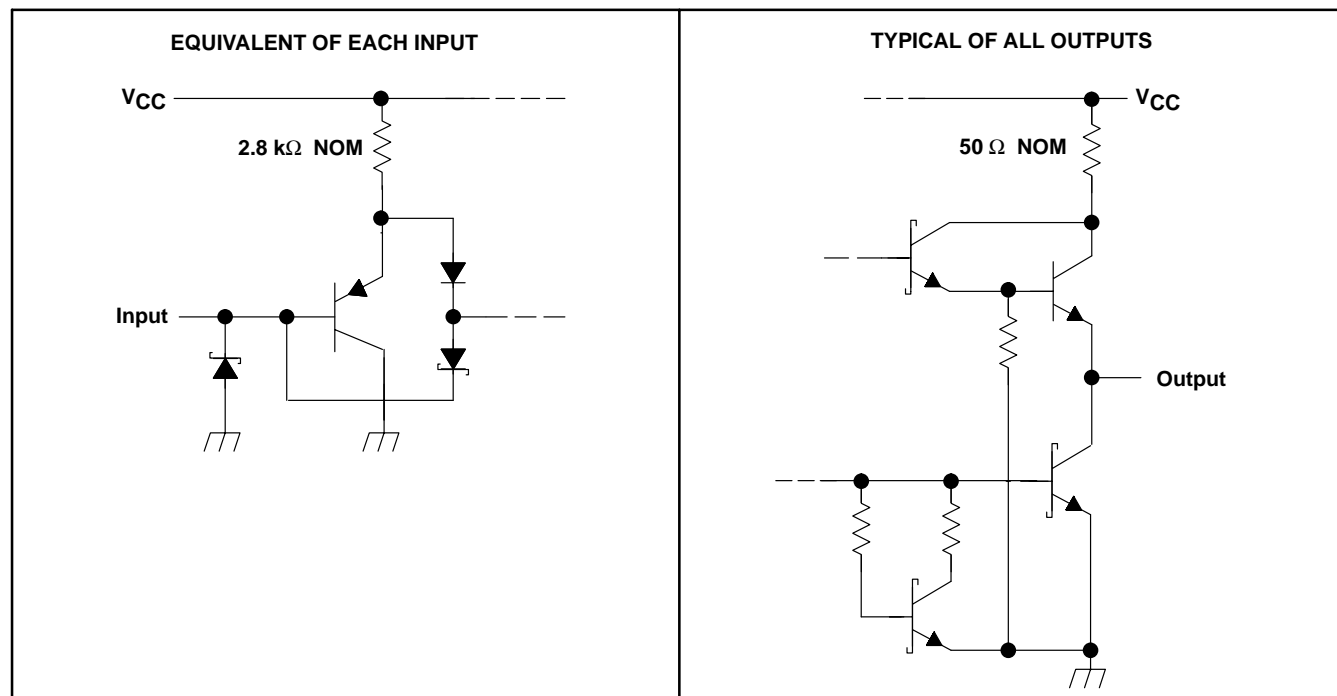
TEXAS INSTRUMENTS

schematic of inputs and outputs

'S373 and 'S374   'S373 and 'S374

EQUIVALENT OF EACH INPUT   TYPICAL OF ALL OUTPUTS

V_{CC}   2.8 kΩ NOM   Input

V_{CC}   50 Ω NOM   Output

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)† ('S devices)

Supply voltage, V_{CC} (see Note 1) .... 7 V
Input voltage, V_I .... 5.5 V
Off-state output voltage .... 5.5 V
Package thermal impedance, θ_{JA} (see Note 2): DW package .... 58°C/W
                  N package .... 69°C/W
                  NS package .... 60°C/W
Storage temperature range, T_{stg} .... −65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
NOTES: 1. Voltage values are with respect to network ground terminal.
     2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

			SN54S'			SN74S'			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
V_{OH}	High-level output voltage				5.5			5.5	V
I_{OH}	High-level output current				−2			−6.5	mA
t_w	Pulse duration, clock/enable	High	6			6			ns
		Low	7.3			7.3			
t_{su}	Data setup time	'S373	0↓			0↓			ns
		'S374	5↑			5↑			
t_h	Data hold time	'S373	10↓			10↓			ns
		'S374	2↑			2↑			
T_A	Operating free-air temperature		−55		125	0		70	°C

TEXAS
INSTRUMENTS

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (SN54S373, SN54S374, SN74S373, SN74S374)

PARAMETER		TEST CONDITIONS†				MIN	TYP‡	MAX	UNIT
V_{IH}						2			V
V_{IL}								0.8	V
V_{IK}		V_{CC} = MIN,	I_I = –18 mA					–1.2	V
V_{OH}	SN54S'	V_{CC} = MIN,	V_{IH} = 2 V,	V_{IL} = 0.8 V,	I_{OH} = MAX	2.4	3.4		V
	SN74S'					2.4	3.1		
V_{OL}		V_{CC} = MIN,	V_{IH} = 2 V,	V_{IL} = 0.8 V,	I_{OL} = 20 mA			0.5	V
I_{OZH}		V_{CC} = MAX,	V_{IH} = 2 V,	V_O = 2.4 V				50	μA
I_{OZL}		V_{CC} = MAX,	V_{IH} = 2 V,	V_O = 0.5 V				–50	μA
I_I		V_{CC} = MAX,	V_I = 5.5 V					1	mA
I_{IH}		V_{CC} = MAX,	V_I = 2.7 V					50	μA
I_{IL}		V_{CC} = MAX,	V_I = 0.5 V					–250	μA
I_{OS}§		V_{CC} = MAX				–40		–100	mA
I_{CC}		V_{CC} = MAX	'S373	Outputs high				160	mA
				Outputs low				160	
				Outputs disabled				190	
			'S374	Outputs high				110	
				Outputs low				140	
				Outputs disabled				160	
				CLK and $\overline{OC}$ at 4 V, D inputs at 0 V				180	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time and duration of the short circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'S373			'S374			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
f_{max}			R_L = 280 Ω, C_L = 15 pF, See Note 3				75	100		MHz
t_{PLH}	Data	Any Q	R_L = 280 Ω, C_L = 15 pF, See Note 3		7	12				ns
t_{PHL}					7	12				
t_{PLH}	C or CLK	Any Q	R_L = 280 Ω, C_L = 15 pF, See Note 3		7	14		8	15	ns
t_{PHL}					12	18		11	17	
t_{PZH}	$\overline{OC}$	Any Q	R_L = 280 Ω, C_L = 15 pF, See Note 3		8	15		8	15	ns
t_{PZL}					11	18		11	18	
t_{PHZ}	$\overline{OC}$	Any Q	R_L = 280 Ω, C_L = 5 pF		6	9		5	9	ns
t_{PLZ}					8	12		7	12	

NOTE 3.   Maximum clock frequency is tested with all outputs loaded.
f_{max} = maximum clock frequency
t_{PLH} = propagation delay time, low-to-high-level output
t_{PHL} = propagation delay time, high-to-low-level output
t_{PZH} = output enable time to high level
t_{PZL} = output enable time to low level
t_{PHZ} = output disable time from high level
t_{PLZ} = output disable time from low level

TEXAS
INSTRUMENTS

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PARAMETER MEASUREMENT INFORMATION
SERIES 54LS/74LS DEVICES
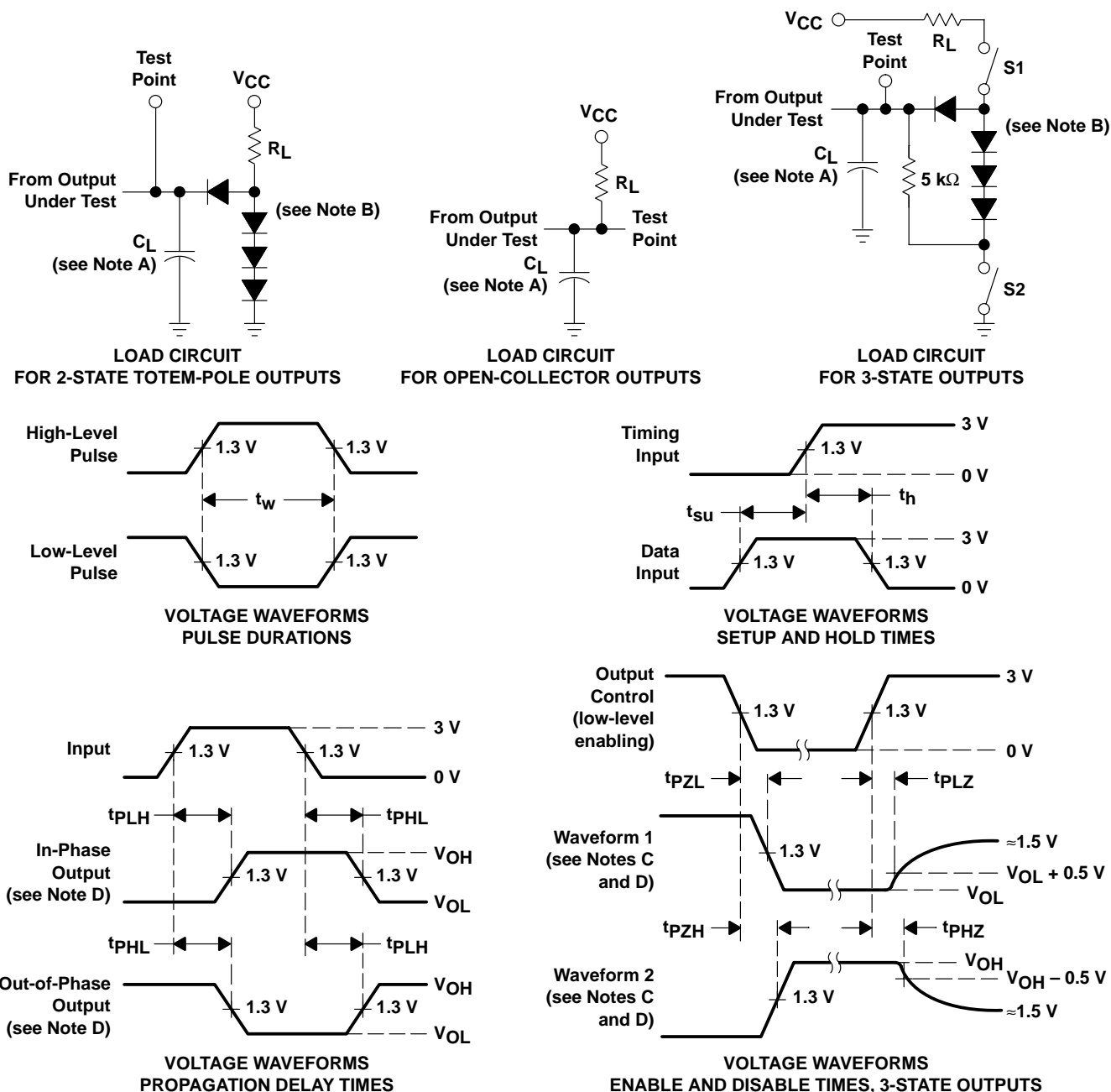
LOAD CIRCUIT FOR 2-STATE TOTEM-POLE OUTPUTS

LOAD CIRCUIT FOR OPEN-COLLECTOR OUTPUTS

LOAD CIRCUIT FOR 3-STATE OUTPUTS

VOLTAGE WAVEFORMS PULSE DURATIONS

VOLTAGE WAVEFORMS SETUP AND HOLD TIMES

VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES

VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

NOTES: A. C_L includes probe and jig capacitance.
B. All diodes are 1N3064 or equivalent.
C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
D. S1 and S2 are closed for t_{PLH}, t_{PHL}, t_{PHZ}, and t_{PLZ}; S1 is open and S2 is closed for t_{PZH}; S1 is closed and S2 is open for t_{PZL}.
E. Phase relationships between inputs and outputs have been chosen arbitrarily for these examples.
F. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z_O ≈ 50 Ω, t_r ≤ 1.5 ns, t_f ≤ 2.6 ns.
G. The outputs are measured one at a time with one input transition per measurement.
H. All parameters and waveforms are not applicable to all devices .

Figure 1. Load Circuits and Voltage Waveforms

TEXAS
INSTRUMENTS

PARAMETER MEASUREMENT INFORMATION
SERIES 54S/74S DEVICES

**LOAD CIRCUIT
FOR 2-STATE TOTEM-POLE OUTPUTS**

**LOAD CIRCUIT
FOR OPEN-COLLECTOR OUTPUTS**

**LOAD CIRCUIT
FOR 3-STATE OUTPUTS**

**VOLTAGE WAVEFORMS
PULSE DURATIONS**

**VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES**

**VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES**

**VOLTAGE WAVEFORMS
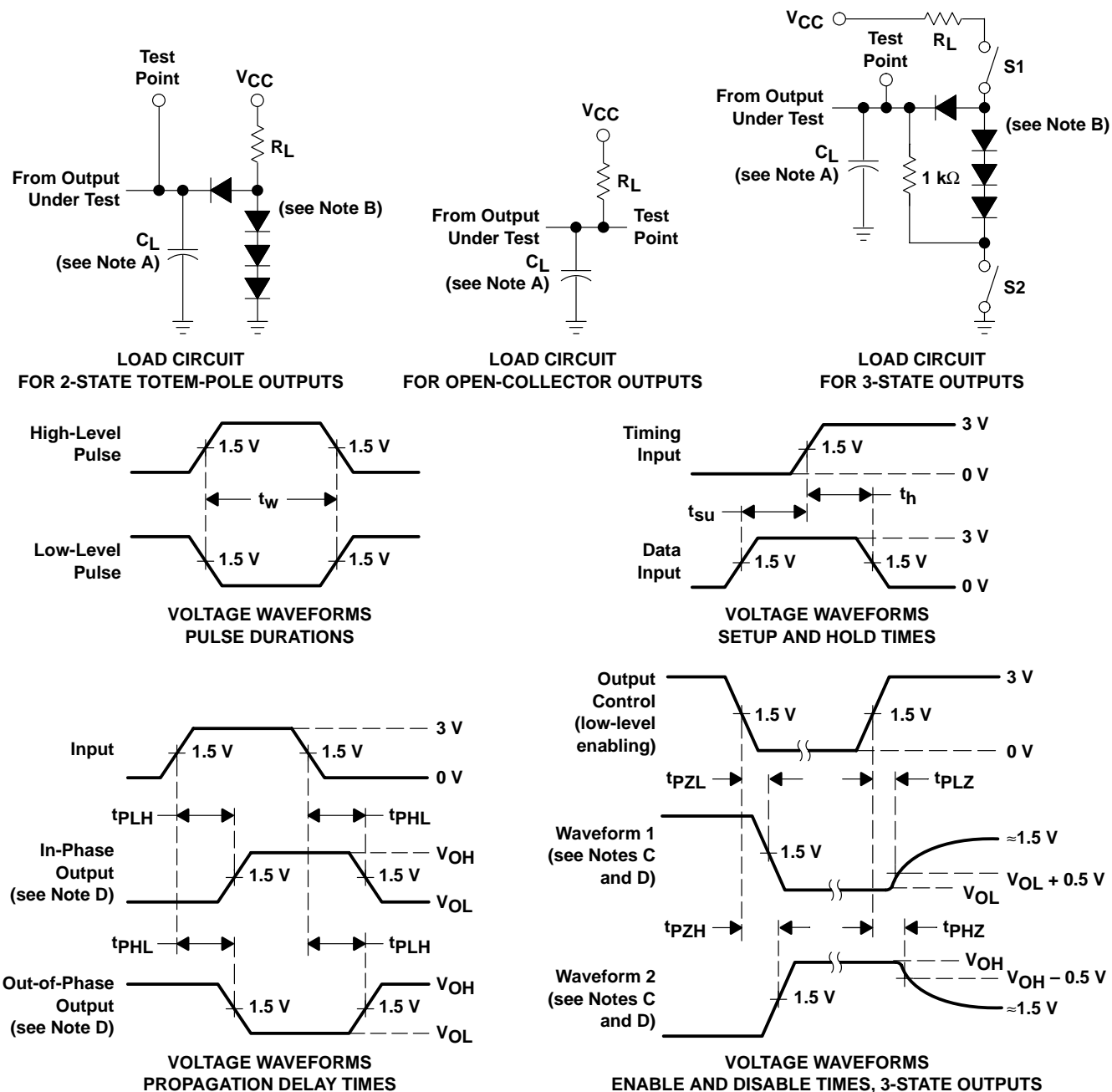ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS**

NOTES: A. C_L includes probe and jig capacitance.
   B. All diodes are 1N3064 or equivalent.
   C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
       Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
   D. S1 and S2 are closed for t_{PLH}, t_{PHL}, t_{PHZ}, and t_{PLZ}; S1 is open and S2 is closed for t_{PZH}; S1 is closed and S2 is open for t_{PZL}.
   E. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z_O ≈ 50 Ω; t_r and t_f ≤ 7 ns for Series
       54/74 devices and t_r and t_f ≤ 2.5 ns for Series 54S/74S devices.
   F. The outputs are measured one at a time with one input transition per measurement.
   G. All parameters and waveforms are not applicable to all devices .

Figure 2. Load Circuits and Voltage Waveforms

**TEXAS
INSTRUMENTS**

TYPICAL APPLICATION DATA

Bidirectional Bus Driver

Clock Circuit for Bus Exchange

Expandable 4-Word by 8-Bit General Register File
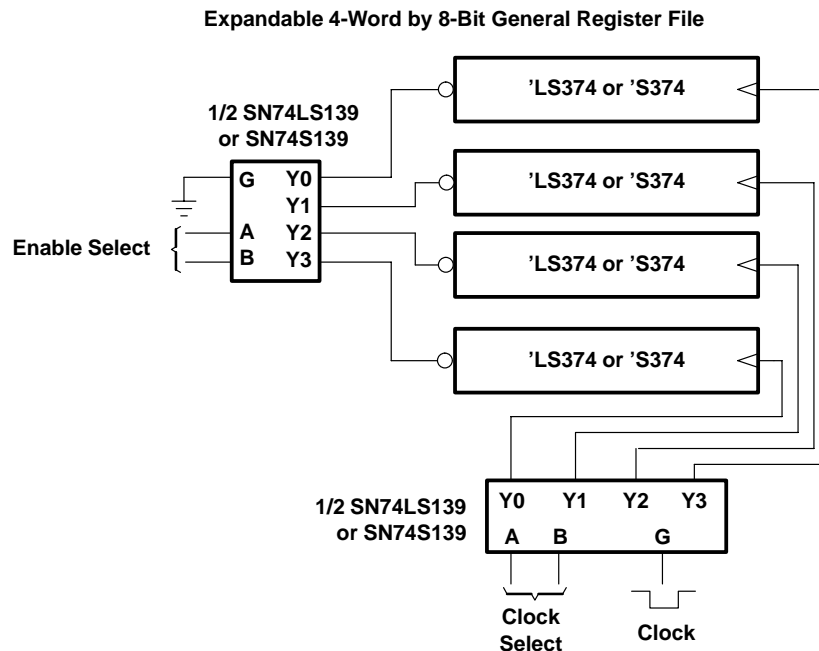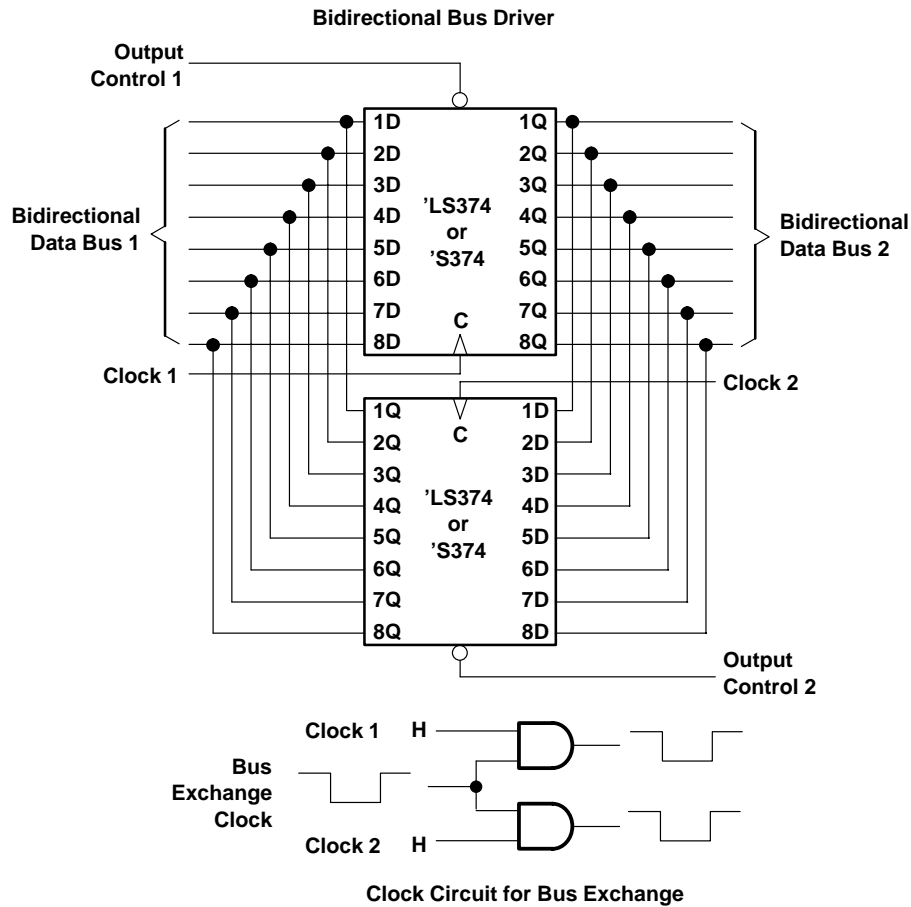
PACKAGING INFORMATION

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
5962-7801102VRA	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
5962-7801102VSA	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC
78011022A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
7801102RA	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
7801102SA	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/32502B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/32502BRA	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/32502BSA	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/32502SRA	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/32502SSA	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/32503B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/32503BRA	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/32503BSA	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC
SN54LS373J	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
SN54LS374J	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
SN54S373J	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
SN54S374J	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
SN74LS373DW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74LS373DWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74LS373N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS373N3	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI
SN74LS373NSR	ACTIVE	SO	NS	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS374DBR	ACTIVE	SSOP	DB	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS374DW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74LS374DWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74LS374J	OBSOLETE	CDIP	J	20		TBD	Call TI	Call TI
SN74LS374N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS374N3	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI
SN74LS374NSR	ACTIVE	SO	NS	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74S373DW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74S373DWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74S373J	OBSOLETE	CDIP	J	20		TBD	Call TI	Call TI
SN74S373N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74S373N3	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
SN74S374DW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74S374DWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74S374J	OBSOLETE	CDIP	J	20		TBD	Call TI	Call TI
SN74S374N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74S374N3	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI
SN74S374NSR	ACTIVE	SO	NS	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SNJ54LS373FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS373J	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS373W	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS374FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS374J	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS374W	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S373FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S373J	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S374FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S374J	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S374W	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC

[1] The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

[3] MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

B

14   8

1   7

$\frac{0.065\ (1,65)}{0.045\ (1,14)}$

C

0.005 (0,13) MIN

$\frac{0.060\ (1,52)}{0.015\ (0,38)}$

0.200 (5,08) MAX

Seating Plane

0.130 (3,30) MIN

$\frac{0.026\ (0,66)}{0.014\ (0,36)}$

0.100 (2,54)

A

0°–15°

$\frac{0.014\ (0,36)}{0.008\ (0,20)}$

4040083/F 03/03

NOTES: A.   All linear dimensions are in inches (millimeters).
         B.   This drawing is subject to change without notice.
         C.   This package is hermetically sealed with a ceramic lid using glass frit.
         D.   Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
         E.   Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R–GDFP–F20)   CERAMIC DUAL FLATPACK

Base and Seating Plane

$\dfrac{0.300\ (7,62)}{0.245\ (6,22)}$

$\dfrac{0.045\ (1,14)}{0.026\ (0,66)}$

$\dfrac{0.100\ (2,45)}{0.045\ (1,14)}$

$\dfrac{0.009\ (0,23)}{0.004\ (0,10)}$

0.320 (8,13) MAX

1

20

0.540 (13,72) MAX

$\dfrac{0.022\ (0,56)}{0.015\ (0,38)}$

0.050 (1,27)

0.005 (0,13) MIN
4 Places

10

11

$\dfrac{0.370\ (9,40)}{0.250\ (6,35)}$

$\dfrac{0.370\ (9,40)}{0.250\ (6,35)}$

4040180–4/D 07/03

NOTES: A.   All linear dimensions are in inches (millimeters).
           B.   This drawing is subject to change without notice.
           C.   This package can be hermetically sealed with a ceramic lid using glass frit.
           D.   Index point is provided on cap for terminal identification only.
           E.   Falls within Mil–Std 1835 GDFP2–F20

FK (S-CQCC-N**)   **LEADLESS CERAMIC CHIP CARRIER**

28 TERMINAL SHOWN

NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.739 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)

0.020 (0,51) / 0.010 (0,25)

0.020 (0,51) / 0.010 (0,25)

0.080 (2,03) / 0.064 (1,63)

0.055 (1,40) / 0.045 (1,14)

0.045 (1,14) / 0.035 (0,89)

0.028 (0,71) / 0.022 (0,54)

0.045 (1,14) / 0.035 (0,89)

0.050 (1,27)

4040140/D 10/96

NOTES: A. All linear dimensions are in inches (millimeters).
        B. This drawing is subject to change without notice.
        C. This package can be hermetically sealed with a metal lid.
        D. The terminals are gold plated.
        E. Falls within JEDEC MS-004

N (R−PDIP−T**)   PLASTIC DUAL−IN−LINE PACKAGE

16 PINS SHOWN

PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS−001 VARIATION	AA	BB	AC	AD

0.260 (6,60)
0.240 (6,10)

0.070 (1,78)
0.045 (1,14)

0.045 (1,14)
0.030 (0,76)

0.020 (0,51) MIN

0.200 (5,08) MAX

Seating Plane

0.125 (3,18) MIN

0.100 (2,54)

0.021 (0,53)
0.015 (0,38)

⊕ 0.010 (0,25) Ⓜ

0.325 (8,26)
0.300 (7,62)

0.015 (0,38)

Gauge Plane

0.010 (0,25) NOM

0.430 (10,92) MAX

14/18 Pin Only
20 Pin vendor option

4040049/E 12/2002

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS−001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW (R−PDSO−G20)　　　　　　　PLASTIC SMALL−OUTLINE PACKAGE

$$\frac{0.512\ (13,00)}{0.496\ (12,60)}$$

20　　　　　　　　　　　　　　11

$$\frac{0.419\ (10,63)}{0.393\ (9,97)}$$

$$\frac{0.299\ (7,60)}{0.291\ (7,40)}$$

1　　　　　　　　　　　　　10

Pin 1
Index Area

0.050 (1,27)

$$\frac{0.020\ (0,51)}{0.012\ (0,31)}$$

⊕ | 0.010 (0,25) Ⓜ

0.104 (2,65) Max

$$\frac{0.012\ (0,30)}{0.004\ (0,10)}$$

$$\frac{0.013\ (0,33)}{0.008\ (0,20)}$$

⌒ | 0.004 (0,10)

Gauge Plane

Seating Plane

0.010 (0,25)　　0°−8°

$$\frac{0.050\ (1,27)}{0.016\ (0,40)}$$

4040000−4/F 06/2004

NOTES:　A.　All linear dimensions are in inches (millimeters).
　　　　　B.　This drawing is subject to change without notice.
　　　　　C.　Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
　　　　　D.　Falls within JEDEC MS−013 variation AC.

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MECHANICAL DATA

NS (R-PDSO-G**)   PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN

PINS ** DIM	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

4040062/C 03/03

NOTES: A.   All linear dimensions are in millimeters.
          B.   This drawing is subject to change without notice.
          C.   Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DB (R-PDSO-G**)　　　　　　　　　　　　　　　　　　　　　　　　**PLASTIC SMALL-OUTLINE**

28 PINS SHOWN

PINS ** DIM	14	16	20	24	28	30	38
A　MAX	6,50	6,50	7,50	8,50	10,50	10,50	12,90
A　MIN	5,90	5,90	6,90	7,90	9,90	9,90	12,30

4040065 /E 12/01

NOTES:　A.　All linear dimensions are in millimeters.
　　　　　B.　This drawing is subject to change without notice.
　　　　　C.　Body dimensions do not include mold flash or protrusion not to exceed 0,15.
　　　　　D.　Falls within JEDEC MO-150

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